

## High Temperature Silicon Carbide Power Schottky Diode

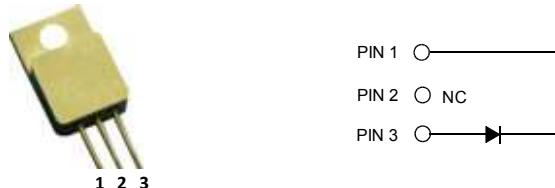
<b>V<sub>RRM</sub></b>	=	1200 V
<b>V<sub>F</sub></b>	=	1.6 V
<b>I<sub>F</sub></b>	=	10 A
<b>Q<sub>C</sub></b>	=	95 nC

### Features

- 1200 V Schottky rectifier
- 250 °C maximum operating temperature
- Electrically isolated base-plate
- Zero reverse recovery charge
- Superior surge current capability
- Positive temperature coefficient of V<sub>F</sub>
- Temperature independent switching behavior
- Lowest figure of merit Q<sub>C</sub>/I<sub>F</sub>
- Available screened to Mil-PRF-19500

### Package

- RoHS Compliant



**TO – 257 (Isolated Base-plate Hermetic Package)**

### Advantages

- High temperature operation
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Industry's lowest reverse recovery charge
- Industry's lowest device capacitance
- Ideal for output switching of power supplies
- Best in class reverse leakage current at operating temperature

### Applications

- Down Hole Oil Drilling, Geothermal Instrumentation
- High Temperature DC/DC Converters
- High Temperature Motor and Servo Drives
- High Temperature Inverters
- High Temperature Actuator Control
- Military Power Supplies

### Maximum Ratings at T<sub>j</sub> = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V <sub>RRM</sub>		1200	V
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> ≤ 225 °C	9.4	A
RMS forward current	I <sub>F(RMS)</sub>	T <sub>C</sub> ≤ 225 °C	16	A
Surge non-repetitive forward current, Half Sine Wave	I <sub>F,SM</sub>	T <sub>C</sub> = 25 °C, t <sub>p</sub> = 10 ms	45	A
Non-repetitive peak forward current	I <sub>F,max</sub>	T <sub>C</sub> = 25 °C, t <sub>p</sub> = 10 μs	tbd	A
I <sup>2</sup> t value	∫I <sup>2</sup> dt	T <sub>C</sub> = 25 °C, t <sub>p</sub> = 10 ms	tbd	A <sup>2</sup> S
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> = 25 °C	208	W
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>		-55 to 250	°C

### Electrical Characteristics at T<sub>j</sub> = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 A, T <sub>j</sub> = 25 °C	1.6	2.3		V
		I <sub>F</sub> = 10 A, T <sub>j</sub> = 210 °C	2.3			
Reverse current	I <sub>R</sub>	V <sub>R</sub> = 1200 V, T <sub>j</sub> = 25 °C	1.2	20	300	μA
		V <sub>R</sub> = 1200 V, T <sub>j</sub> = 250 °C	56			
Total capacitive charge	Q <sub>C</sub>	I <sub>F</sub> ≤ I <sub>F,MAX</sub> dI <sub>F</sub> /dt = 200 A/μs T <sub>j</sub> = 210 °C	V <sub>R</sub> = 400 V V <sub>R</sub> = 960 V	58		nC
			V <sub>R</sub> = 400 V V <sub>R</sub> = 960 V	95		
Switching time	t <sub>s</sub>	V <sub>R</sub> = 1 V, f = 1 MHz, T <sub>j</sub> = 25 °C V <sub>R</sub> = 400 V, f = 1 MHz, T <sub>j</sub> = 25 °C V <sub>R</sub> = 1000 V, f = 1 MHz, T <sub>j</sub> = 25 °C	< 49		ns	
			V <sub>R</sub> = 1 V, f = 1 MHz, T <sub>j</sub> = 25 °C V <sub>R</sub> = 400 V, f = 1 MHz, T <sub>j</sub> = 25 °C V <sub>R</sub> = 1000 V, f = 1 MHz, T <sub>j</sub> = 25 °C	884		
Total capacitance	C	V <sub>R</sub> = 1 V, f = 1 MHz, T <sub>j</sub> = 25 °C V <sub>R</sub> = 400 V, f = 1 MHz, T <sub>j</sub> = 25 °C V <sub>R</sub> = 1000 V, f = 1 MHz, T <sub>j</sub> = 25 °C	79	63	pF	

### Thermal Characteristics

Thermal resistance, junction - case	R <sub>thJC</sub>	1.08	°C/W
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### Mechanical Properties

Mounting torque	M	0.6	Nm
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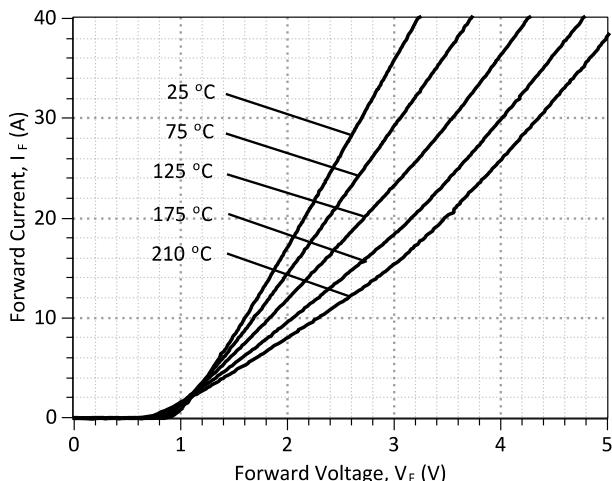


Figure 1: Typical Forward Characteristics

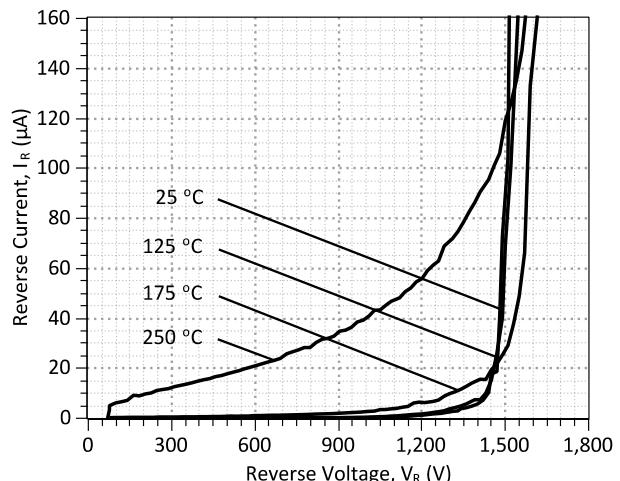


Figure 2: Typical Reverse Characteristics

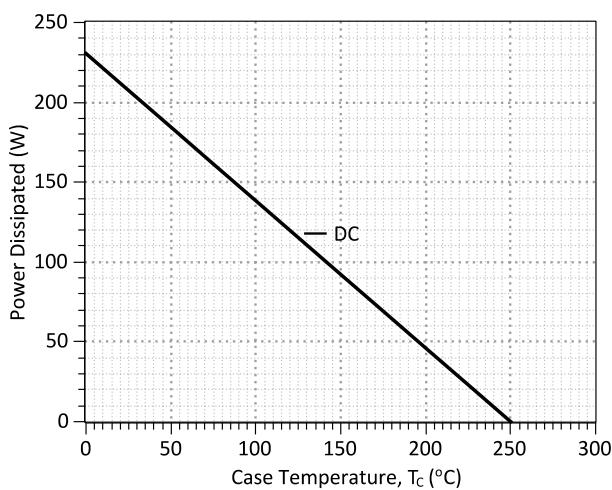


Figure 3: Power Derating Curve

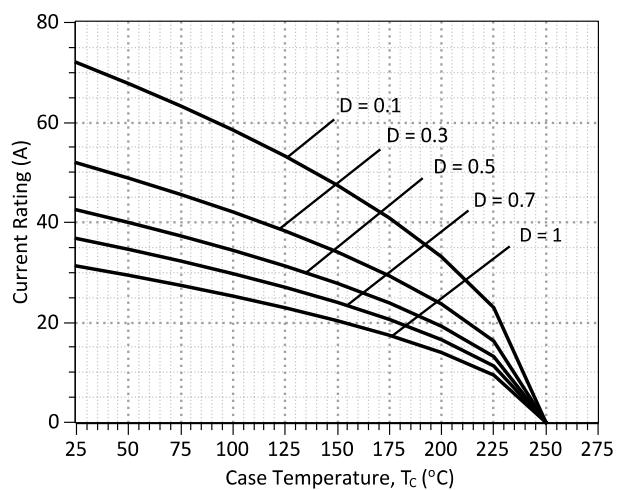


Figure 4: Current Derating Curves ( $D = t_p/T$ ,  $t_p = 400 \mu s$ )  
 (Considering worst case  $Z_{th}$  conditions )

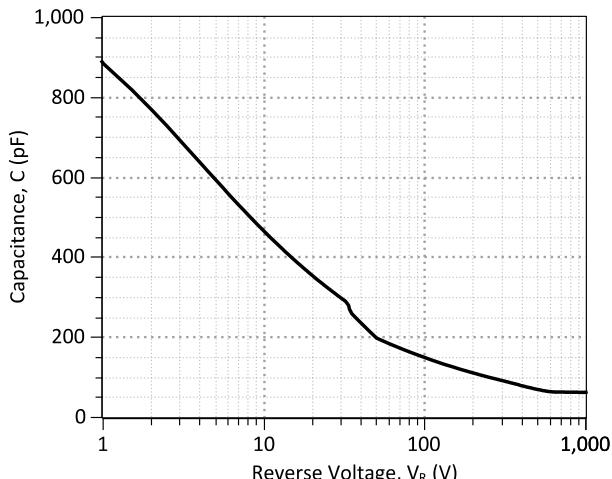


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

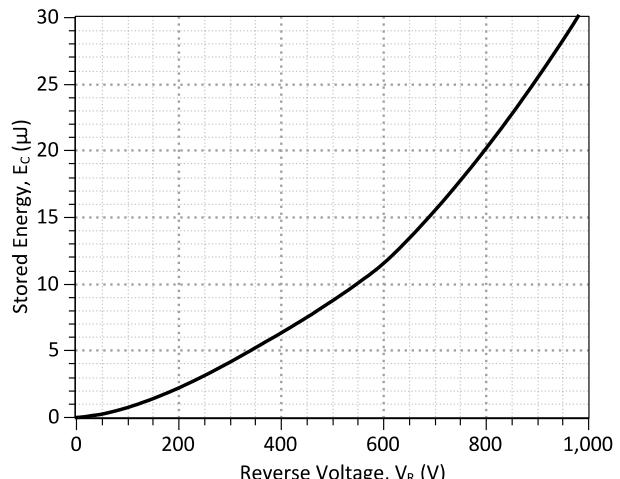


Figure 6: Typical Switching Energy vs Reverse Voltage Characteristics

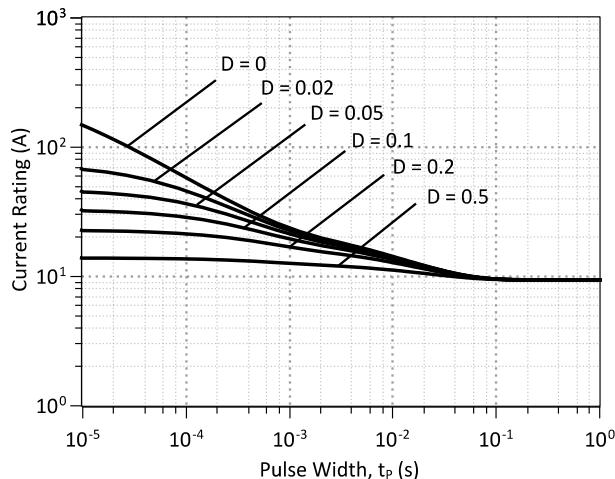


Figure 7: Current vs Pulse Duration Curves at  $T_c = 225\text{ }^\circ\text{C}$

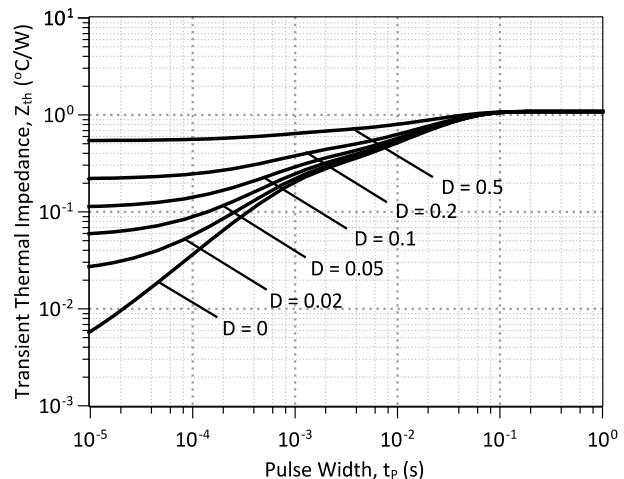
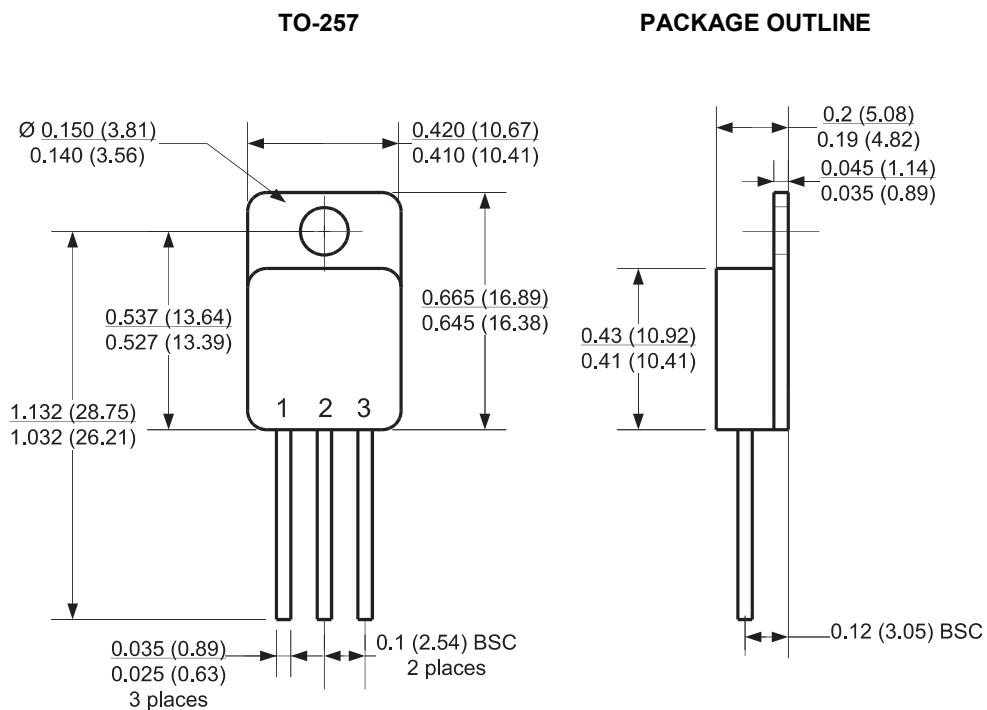


Figure 8: Transient Thermal Impedance

### Package Dimensions:



#### NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

<b>Revision History</b>			
Date	Revision	Comments	Supersedes
2012/04/24	0	Initial release	

## Published by

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## SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the 1N8028-GA device.

```
* MODEL OF GeneSiC Semiconductor Inc.  
*  
* $Revision: 1.0 $  
* $Date: 05-SEP-2013 $  
*  
* GeneSiC Semiconductor Inc.  
* 43670 Trade Center Place Ste. 155  
* Dulles, VA 20166  
* http://www.genesicsemi.com/index.php/sic-products/schottky  
*  
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*  
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY  
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED  
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A  
* PARTICULAR PURPOSE."  
* Models accurate up to 2 times rated drain current.  
*  
* Start of 1N8028-GA SPICE Model  
*  
.SUBCKT 1N8028 ANODE KATHODE  
D1 ANODE KATHODE 1N8028_25C; Call the Schottky Diode Model  
D2 ANODE KATHODE 1N8028_PIN; Call the PiN Diode Model  
.MODEL 1N8028_25C D  
+ IS 1.74E-13 RS 0.05105  
+ TRS1 0.005 TRS2 1.68E-5  
+ N 1.2637323 IKF 1.884319  
+ EG 1.2 XTI 3  
+ CJO 1.15E-09 VJ 0.44  
+ M 1.5 FC 0.5  
+ TT 1.00E-10 BV 1500  
+ IBV 1.00E-03 VPK 1200  
+ IAVE 20 TYPE Sic_Schottky  
+ MFG GeneSiC_Semiconductor  
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+ IS 5.15E-15 RS 0.2  
+ N 3.1605 IKF 0.00055844  
+ EG 3.23 XTI 3  
+ FC 0.5 TT 0  
+ BV 1500 IBV 1.00E-03  
+ VPK 1200 IAVE 20  
+ TYPE Sic_PiN  
.ENDS  
*  
* End of 1N8028-GA SPICE Model
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